

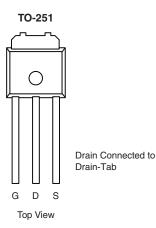
RoHS

COMPLIANT

IRFU4615PBF-VB Datasheet

N-Channel 200V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)			
200	0.056 at V _{GS} = 10 V	25			
200	0.070 at V _{GS} = 6 V	23			

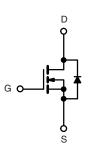


FEATURES

- Trench Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)							
Parameter	Symbol	Limit	Unit				
Drain-Source Voltage	V _{DS}	200	V				
Gate-Source Voltage	V _{GS}	± 20	v				
Continuous Durin Quarant (T. 175 °C)	T _C = 25 °C	1-	25				
Continuous Drain Current $(T_J = 175 \ ^{\circ}C)^b$	T _C = 125 °C	I I _D	17				
Pulsed Drain Current	I _{DM}	60	А				
Continuous Source Current (Diode Conduction)	۱ _S	19					
Avalanche Current	I _{AS}	25					
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	18	mJ			
Maximum Dawar Dissinction	T _C = 25 °C	P _D	145 ^b	w			
Maximum Power Dissipation	T _A = 25 °C		3.5 ^a	vv			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C				

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
	t ≤ 10 s	P	15	18			
Junction-to-Ambient ^a	Steady State	R _{thJA}	40	50	°C/W		
Junction-to-Case (Drain)		R _{thJC}	0.85	1.1			

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See SOA curve for voltage derating.

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	Min.	Typ. ^a	Max.	Unit		
μA	200			N/		
μA	2		4	V		

Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	200				
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 125 °C			50	μΑ	
		V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	40			Α	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		0.056			
	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		0.130		Ω	
Drain-Source On-State Resistance ^b	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5 \text{ A}, \text{ T}_{J} = 175 \text{ °C}$		0.260			
		$V_{GS} = 6 V, I_D = 5 A$		0.070			
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 19 A		35		S	
Dynamic ^a							
Input Capacitance	C _{iss}			2400		pF	
Output Capacitance	C _{oss}	V_{GS} = 0 V, V_{DS} = 25 V, F = 1 MHz		280			
Reverse Transfer Capacitance	C _{rss}			180			
Total Gate Charge ^c	Qg			40			
Gate-Source Charge ^c	Q _{gs}	V_{DS} = 100 V, V_{GS} = 10 V, I_{D} = 19 A		10		nC	
Gate-Drain Charge ^c	Q _{gd}			15			
Gate Resistance	R _g		0.5		2.9	Ω	
Turn-On Delay Time ^c	t _{d(on)}			15	25		
Rise Time ^c	t _r	V_{DD} = 100 V, R_L = 5.2 Ω		50	75	- ns	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 19 A, V_GEN = 10 V, R_g = 2.5 Ω		30	45		
Fall Time ^c	t _f			60	90		
Source-Drain Diode Ratings and Char	acteristics (1	Γ _C = 25 °C)		·			
Pulsed Current	I _{SM}				50	А	
Diode Forward Voltage ^b	V_{SD}	I _F = 19 A, V _{GS} = 0 V		0.9	1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 19 A, dl/dt = 100 A/μs		180	250	ns	

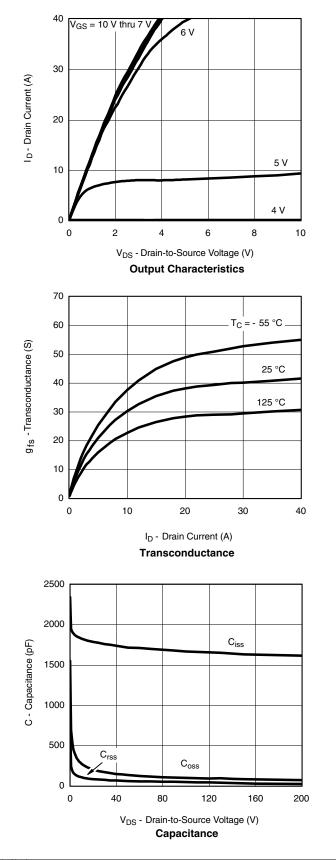
Notes:

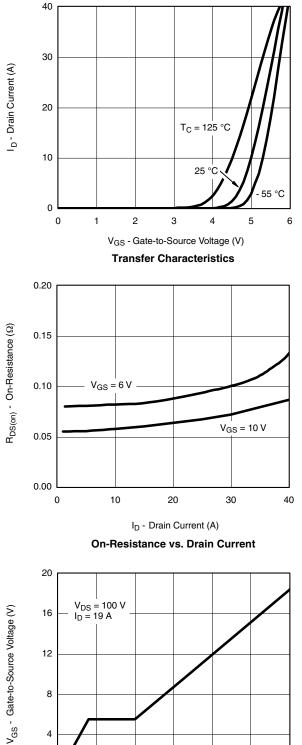
a. Guaranteed by design, not subject to production testing. b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

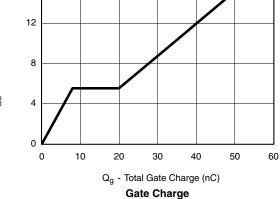
c. Independent of operating temperature.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







服务热线:400-655-8788

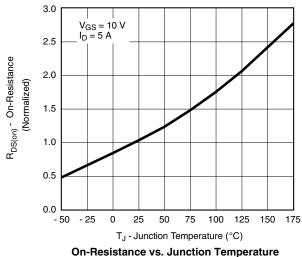


 $T_J = 25 \ ^{\circ}C$

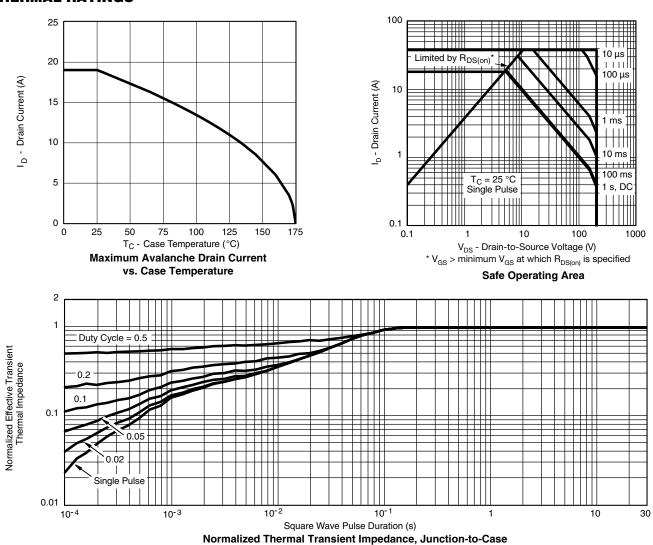
0.9

1.2





THERMAL RATINGS



100

10

1

0

0.3

T_J = 150 °C

0.6

Source-Drain Diode Forward Voltage

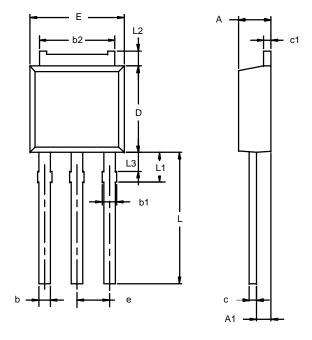
V_{SD} - Source-to-Drain Voltage (V)

I_S - Source Current (A)

IRFU4615PBF-VB



TO-251AA



	MILLIM	IETERS	INC	HES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
E	6.48	6.73	0.255	0.265	
е	2.28	BSC	0.090 BSC		
L	3.89	9.53	0.153	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	

Note: Dimension L3 is for reference only.



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